



## DGD2104

## HALF-BRIDGE GATE DRIVER IN SO-8

#### Description

The DGD2104 is a high-voltage / high-speed gate driver capable of driving N-channel MOSFETs and IGBTs in a half bridge configuration. High-voltage processing techniques enable the DGD2104's high side to switch to 600V in a bootstrap operation.

The DGD2104 logic inputs are compatible with standard TTL and CMOS levels (down to 3.3V) to interface easily with controlling devices. The driver outputs feature high-pulse current buffers designed for minimum driver cross conduction. The DGD2104 has a fixed internal deadtime of 520ns (typical).

The DGD2104 is offered in the SO-8 (Type TH) package and operates over an extended -40°C to +125°C temperature range.

#### Applications

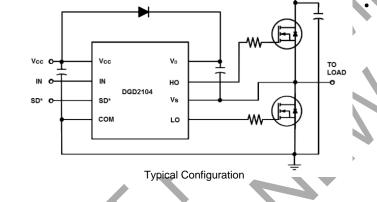
- DC-DC Converters
- DC-AC Inverters
- AC-DC Power Supplies
- Motor Controls
- Class D Power Amplifiers

### Features

- Floating High-Side Driver in Bootstrap Operation to 600V
- Drives Two N-Channel MOSFETs or IGBTs in a Half Bridge Configuration
- 290mA Source / 600mA Sink Output Current Capability
- Outputs Tolerant to Negative Transients
- Internal Dead Time of 520ns to Protect MOSFETs
- Wide Low-Side Gate Driver Supply Voltage: 10V to 20V
- Logic Input (IN and SD\*) 3.3V Capability
- Schmitt Triggered Logic Inputs
- Undervoltage Lockout for V<sub>CC</sub> (Logic and Low Side Supply)
- Extended Temperature Range: -40°C To +125°C
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

#### Mechanical Data

- Case: SO-8 (Type TH)
- Case Material: Molded Plastic. "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads
- Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.074 grams (Approximate)





SO-8 (Type TH) Top View

# Ordering Information (Note 4)

Product	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
DGD2104S8-13	DGD2104	13	12	2,500

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

Up to 600\

2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**



Distance = Distan

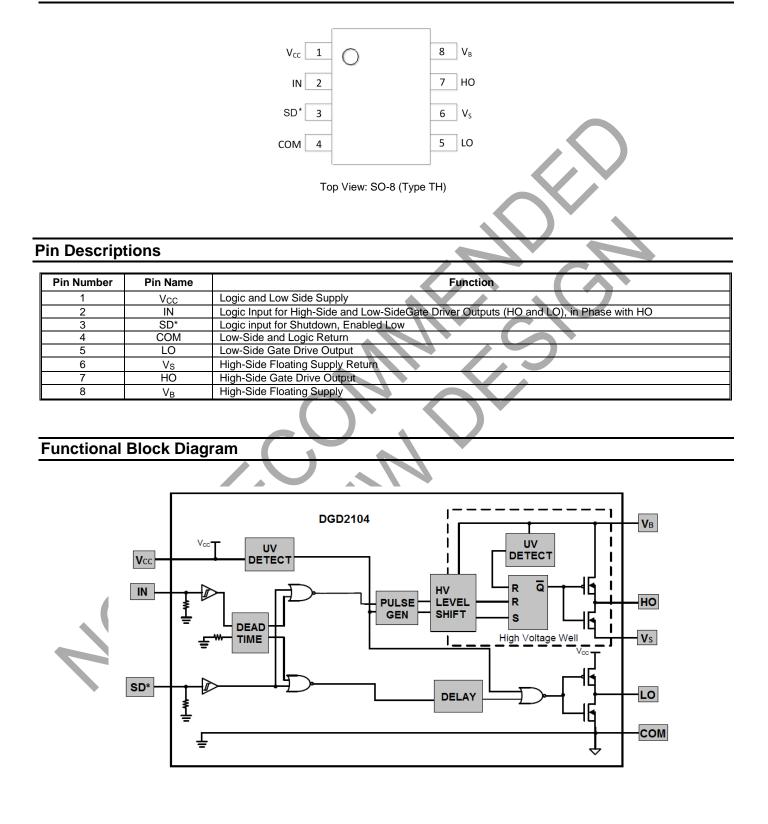
- = Year (ex: 16 = 2016)
- = Week (01 to 53)

YY

WW



# Pin Diagrams





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## **Absolute Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
High-Side Floating Supply Voltage	VB	-0.3 to +624	V	
High-Side Floating Supply Offset Voltage	Vs	V <sub>B</sub> -24 to V <sub>B</sub> +0.3	V	
High-Side Floating Output Voltage	V <sub>HO</sub>	V <sub>S</sub> -0.3 to V <sub>B</sub> +0.3	V	
Offset Supply Voltage Transient	dV <sub>S</sub> / dt	50	V/ns	
Low-Side Fixed Supply Voltage	V <sub>CC</sub>	-0.3 to +24	V	
Low-Side Output Voltage	V <sub>LO</sub>	-0.3 to V <sub>CC</sub> +0.3	V	
Logic Input Voltage (IN and SD*)	V <sub>IN</sub>	-0.3 to V <sub>CC</sub> +0.3	V	

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation Linear derating factor (Note 5)	PD	0.625	W
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>0JA</sub>	200	°C/W
Operating Temperature	TJ	+150	
Lead Temperature (Soldering, 10s)	TL 🛑	+300	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	

Note: 5. When mounted on a standard JEDEC 2-layer FR-4 board.

# **Recommended Operating Conditions**

Parameter	Symbol	Min	Max	Unit
High Side Floating Supply Absolute Voltage	VB	V <sub>S</sub> + 10	V <sub>S</sub> + 20	V
High Side Floating Supply Offset Voltage	Vs	(Note 6)	600	V
High Side Floating Output Voltage	V <sub>HO</sub>	Vs	VB	V
Low Side Fixed Supply Voltage	V <sub>CC</sub>	10	20	V
Low Side Output Voltage	VLO	0	Vcc	V
Logic Input Voltage (IN and SD*)	Vin	0	5	V
Ambient Temperature	TA	-40	+125	°C

Note: 6. Logic operation for  $V_S$  of -5V to +600V. Logic state held for  $V_S$  of -5V to - $V_{BS}$ .





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# **DC Electrical Characteristics** ( $V_{BIAS}$ ( $V_{CC}$ , $V_{BS}$ ) = 15V, @T<sub>A</sub> = +25°C, unless otherwise specified.) (Note 7)

Parameter	Symbol	Min	Тур	Max	Unit	Condition
Logic "1" (IN) & Logic "0" (SD*) Input Voltage	V <sub>IH</sub>	2.5	-	-	V	$V_{CC} = 10V$ to 20V
Logic "0" (IN) & Logic "1" (SD*) Input Voltage	VIL	-	-	0.8	V	$V_{CC}$ = 10V to 20V
High Level Output Voltage, V <sub>BIAS</sub> - V <sub>O</sub>	V <sub>OH</sub>	-	0.05	0.2	V	$I_0 = 2mA$
Low Level Output Voltage, V <sub>O</sub>	V <sub>OL</sub>	-	0.02	0.1	V	$I_0 = 2mA$
Offset Supply Leakage Current	I <sub>LK</sub>	-	-	50	μA	$V_{B} = V_{S} = 600V$
Quiescent V <sub>BS</sub> Supply Current	I <sub>BSQ</sub>	-	60	100	μA	$V_{IN} = 0V \text{ or } 5V$
Quiescent V <sub>CC</sub> Supply Current	Iccq	-	350	500	μA	$V_{IN} = 0V \text{ or } 5V$
Logic "1" Input Bias Current	I <sub>IN+</sub>	-	3.0	10	μA	$V_{IN} = 5V, SD^* = 0V$
Logic "0" Input Bias Current	I <sub>IN-</sub>	-	-	5.0	μA	V <sub>IN</sub> = 0V, SD* = 5V
V <sub>CC</sub> Supply Undervoltage Positive Going Threshold	V <sub>CCUV+</sub>	8.0	8.9	9.8	V	-
V <sub>CC</sub> Supply Undervoltage Negative Going Threshold	V <sub>CCUV-</sub>	7.4	8.2	9.0	V	-
Output High Short Circuit Pulsed Current	I <sub>O+</sub>	130	290		mA	V <sub>O</sub> = 0V, PW ≤ 10µs
Output Low Short Circuit Pulsed Current	I <sub>O-</sub>	270	600	-	mA	V <sub>O</sub> = 15V, PW ≤ 10µs

Note: 7. The V<sub>IN</sub> and I<sub>IN</sub> parameters are applicable to the two logic pins: IN and SD\*. The V<sub>O</sub> and I<sub>O</sub> parameters are applicable to the respective output pins: HO and LO.

# AC Electrical Characteristics (V<sub>BIAS</sub> (V<sub>CC</sub>, V<sub>BS</sub>) = 15V, C<sub>L</sub> = 1000pF, @T<sub>A</sub> = +25°C, unless otherwise specified.)

Parameter	Symbol	Min	Тур	Max	Unit	Condition
Turn-On Propagation Delay	ton		680	820	ns	$V_{\rm S} = 0V$
Turn-Off Propagation Delay	tOFF	-	150	220	ns	$V_{S} = 600 V$
Shutdown Propagation Delay	tsp	· -	160	220	ns	-
Delay Matching, HO and LO Turn-On/Turn-Off	t <sub>DM</sub>	-	-	60	ns	-
Turn-On Rise Time	t <sub>R</sub>	-	70	170	ns	$V_{\rm S} = 0V$
Turn-Off Fall Time	tF	-	35	90	ns	$V_{\rm S} = 0V$
Deadtime: t <sub>DT LO-HO</sub> & t <sub>DT HO-LO</sub>	t <sub>DT</sub>	400	520	650	ns	-





**Timing Waveforms** 

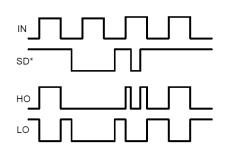


Figure 1. Input / Output Timing Diagram

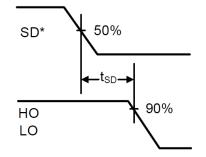
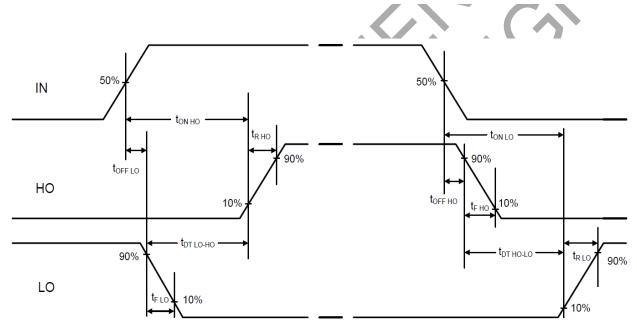


Figure 2. Shutdown Waveform Definition



 $\begin{array}{l} \text{Deadtime } t_{\text{DT LO-HO}} = t_{\text{ON HO}} \text{-} t_{\text{OFF LO}} \\ t_{\text{DT HO-LO}} = t_{\text{ON LO}} \text{-} t_{\text{OFF HO}} \end{array}$ 

Deadtime matching  $t_{MDT} = t_{DT LO-HO} - t_{DT HO-LO}$ 

 $\begin{array}{l} \text{Delay matching} \\ t_{\text{DM OFF}} = t_{\text{OFF LO}} - t_{\text{OFF HO}} \\ t_{\text{DM ON}} = t_{\text{ON LO}} - t_{\text{ON HO}} \end{array}$ 



Figure 3. Switching Time Waveform Definitions



# Typical Performance Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

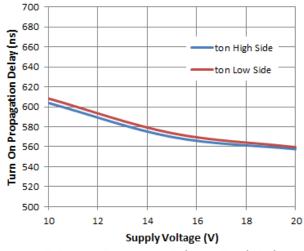


Figure 4. Turn-on Propagation Delay vs. Supply Voltage

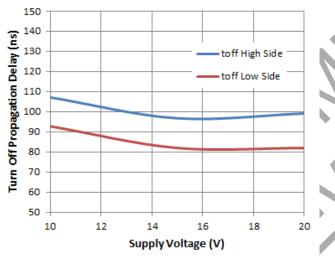
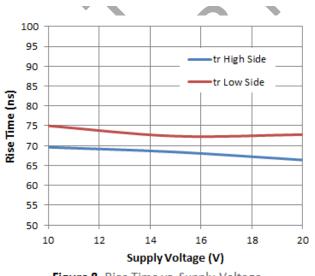


Figure 6. Turn-off Propagation Delay vs. Supply Voltage





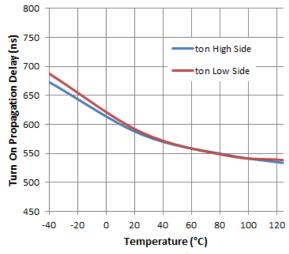


Figure 5. Turn-on Propagation Delay vs. Temperature

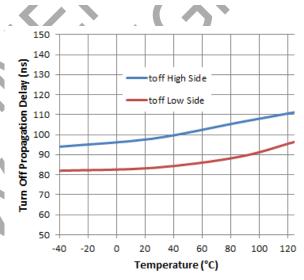


Figure 7. Turn-off Propagation Delay vs. Temperature

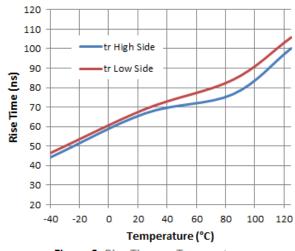
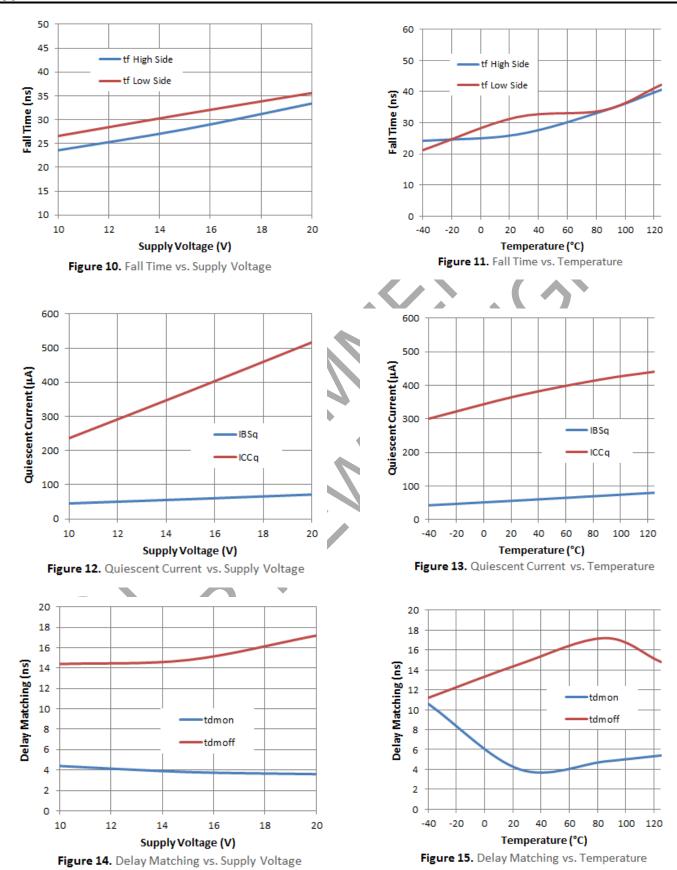


Figure 9. Rise Time vs. Temperature



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## Typical Performance Characteristics (Cont.)





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# Typical Performance Characteristics (Cont.)

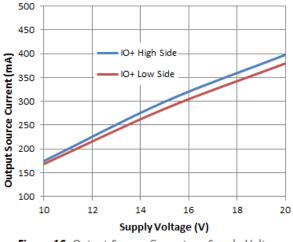


Figure 16. Output Source Current vs. Supply Voltage

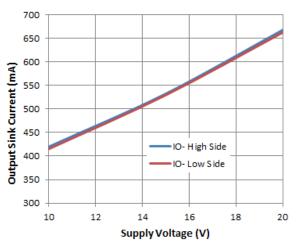


Figure 18. Output Sink Current vs. Supply Voltage

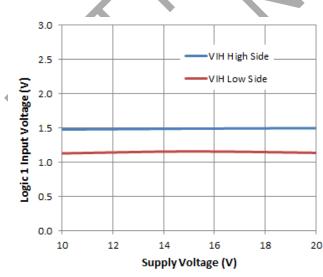
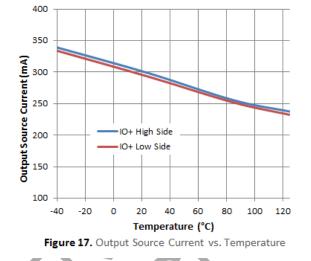
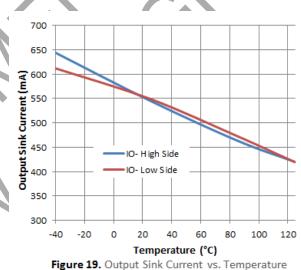
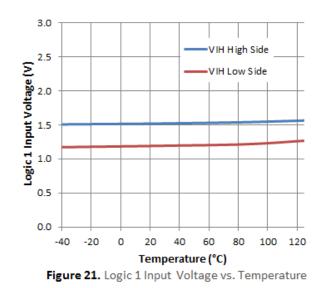


Figure 20. Logic 1 Input Voltage vs. Supply Voltage









3.0

2.5

2.0

1.5

1.0

0.5

0.0

-40 -20

20

0

40

Temperature (°C)

Figure 23. Logic 0 Input Voltage vs. Temperature

60 80

100 120

Logic 0 Input Voltage (V)

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VIL High Side

VIL Low Side

## Typical Performance Characteristics (Cont.)

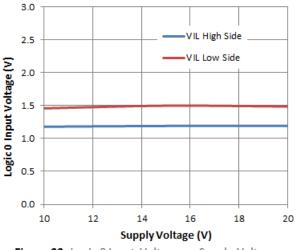


Figure 22. Logic O Input Voltage vs. Supply Voltage

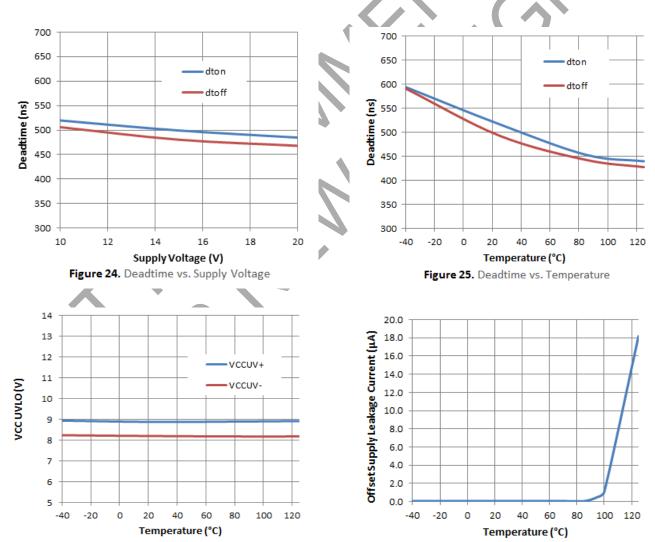




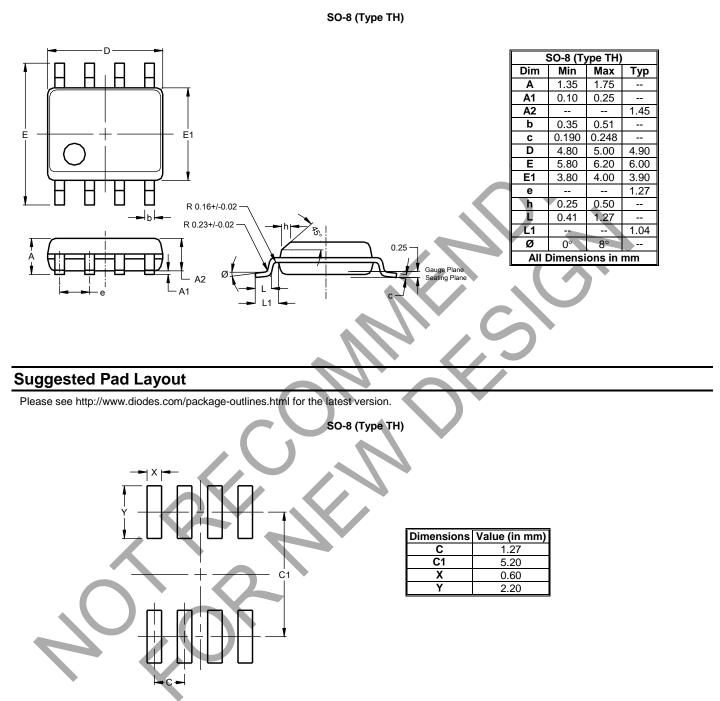
Figure 27. Offset Supply Leakage Current vs. Temperature



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## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.



Note : For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device Terminals and PCB tracking.



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